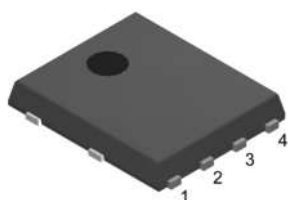
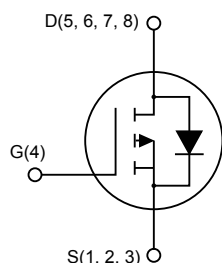


# P-channel 30 V, 24 mΩ typ., 9 A STripFET F6 DeepGATE Power MOSFET in a PowerFLAT 5x6 package



PowerFLAT 5x6



AM01475v4

## Features

| Order code  | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> | P <sub>TOT</sub> |
|-------------|-----------------|--------------------------|----------------|------------------|
| STL30P3LLH6 | 30 V            | 30 mΩ                    | 9 A            | 4.8 W            |

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

## Applications

- Switching applications

## Description

This device is a P-channel Power MOSFET developed using the STripFET F6 technology, with a new trench gate structure. The resulting Power MOSFET exhibits very low R<sub>DS(on)</sub> in all packages.



### Product status link

[STL30P3LLH6](#)

### Product summary

|            |               |
|------------|---------------|
| Order code | STL30P3LLH6   |
| Marking    | 30P3L         |
| Package    | PowerFLAT 5x6 |
| Packing    | Tape and reel |

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

| Symbol            | Parameter                                                           | Value      | Unit |
|-------------------|---------------------------------------------------------------------|------------|------|
| $V_{DS}$          | Drain-source voltage                                                | 30         | V    |
| $V_{GS}$          | Gate-source voltage                                                 | $\pm 20$   | V    |
| $I_D^{(1)}$       | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$      | 30         | A    |
|                   | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$     | 18.75      | A    |
| $I_D^{(2)}$       | Drain current (continuous) at $T_{pcb} = 25\text{ }^\circ\text{C}$  | 9          | A    |
|                   | Drain current (continuous) at $T_{pcb} = 100\text{ }^\circ\text{C}$ | 6.4        | A    |
| $I_{DM}^{(2)(3)}$ | Drain current (pulsed)                                              | 36         | A    |
| $P_{TOT}^{(1)}$   | Total power dissipation at $T_C = 25\text{ }^\circ\text{C}$         | 75         | W    |
| $P_{TOT}^{(2)}$   | Total power dissipation at $T_{pcb} = 25\text{ }^\circ\text{C}$     | 4.8        | W    |
|                   | Derating factor <sup>(2)</sup>                                      | 0.03       | W/°C |
| $T_{stg}$         | Storage temperature range                                           | -55 to 175 | °C   |
| $T_J$             | Operating junction temperature range                                | 175        | °C   |

1. This value is rated according to  $R_{thj-c}$ .
2. This value is rated according to  $R_{thj-pcb}$ .
3. Pulse width is limited by safe operating area.

**Table 2. Thermal data**

| Symbol              | Parameter                                         | Value | Unit |
|---------------------|---------------------------------------------------|-------|------|
| $R_{thj-case}$      | Thermal resistance junction-case max              | 2.00  | °C/W |
| $R_{thj-pcb}^{(1)}$ | Thermal resistance junction-pcb, single operation | 31.3  | °C/W |

1. When mounted on an FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, steady state.

**Note:** For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

## 2 Electrical characteristics

$T_C = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

**Table 3. On/off states**

| Symbol        | Parameter                         | Test conditions                                                                      | Min. | Typ. | Max.      | Unit          |
|---------------|-----------------------------------|--------------------------------------------------------------------------------------|------|------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                               | 30   |      |           | V             |
| $I_{DSS}$     | Zero gate voltage drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 30\text{ V}$                                       |      |      | 1         | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 30\text{ V}$ , $T_C = 125\text{ }^{\circ}\text{C}$ |      |      | 10        | $\mu\text{A}$ |
| $I_{GSS}$     | Gate-body leakage current         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$                                   |      |      | $\pm 100$ | nA            |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                   | 1    |      |           | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 4.5\text{ A}$                                        |      | 24   | 30        | m $\Omega$    |
|               |                                   | $V_{GS} = 4.5\text{ V}$ , $I_D = 4.5\text{ A}$                                       |      | 32   | 40        | m $\Omega$    |

**Table 4. Dynamic**

| Symbol    | Parameter                    | Test conditions                                                                                                    | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $C_{iss}$ | Input capacitance            | $V_{GS} = 0\text{ V}$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$                                                | -    | 1450 | -    | pF   |
| $C_{oss}$ | Output capacitance           |                                                                                                                    | -    | 178  | -    | pF   |
| $C_{rss}$ | Reverse transfer capacitance |                                                                                                                    | -    | 120  | -    | pF   |
| $Q_g$     | Total gate charge            | $V_{DD} = 24\text{ V}$ , $I_D = 9\text{ A}$ , $V_{GS} = 4.5\text{ V}$<br>(see Figure 13. Gate charge test circuit) | -    | 12   | -    | nC   |
| $Q_{gs}$  | Gate-source charge           |                                                                                                                    | -    | 4.4  | -    | nC   |
| $Q_{gd}$  | Gate-drain charge            |                                                                                                                    | -    | 5    | -    | nC   |

**Table 5. Switching times**

| Symbol       | Parameter           | Test conditions                                                                                                                                                           | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 24\text{ V}$ , $I_D = 4.5\text{ A}$ ,<br>$R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$<br>(see Figure 12. Switching times test circuit for resistive load) | -    | 15   | -    | ns   |
| $t_r$        | Rise time           |                                                                                                                                                                           | -    | 15   | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time |                                                                                                                                                                           | -    | 24   | -    | ns   |
| $t_f$        | Fall time           |                                                                                                                                                                           | -    | 21   | -    | ns   |

**Note:** For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

**Table 6. Source-drain diode**

| Symbol          | Parameter                     | Test conditions                                                                                                                                                                                                     | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $I_{SD}$        | Source-drain current          |                                                                                                                                                                                                                     | -    |      | 9    | A    |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |                                                                                                                                                                                                                     | -    |      | 36   | A    |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS} = 0\text{ V}$ , $I_{SD} = 4.5\text{ A}$                                                                                                                                                                     | -    |      | 1.1  | V    |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 4.5\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 16\text{ V}$ , $T_J = 150\text{ }^\circ\text{C}$<br>(see Figure 14. Test circuit for inductive load switching and diode recovery times) | -    | 15   |      | ns   |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                     | -    | 6.5  |      | nC   |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                     | -    | 0.9  |      | A    |

1. Pulse width is limited by safe operating area.

2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

**Note:** For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

## 2.1 Electrical characteristics (curves)

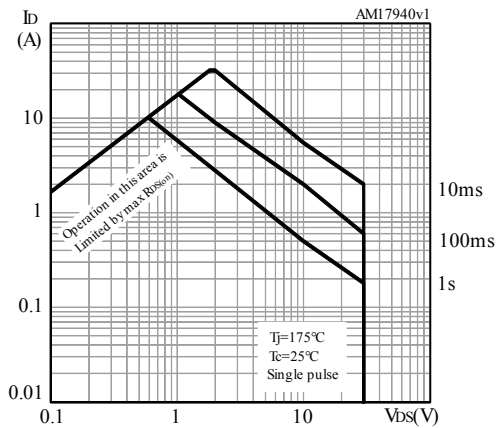
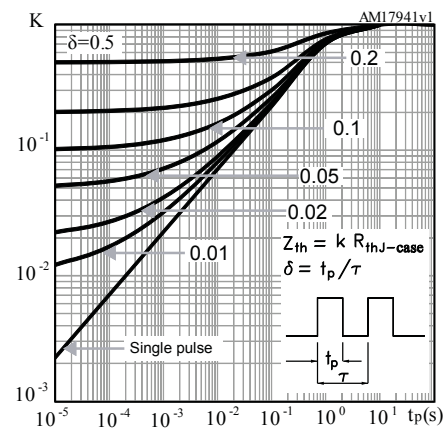
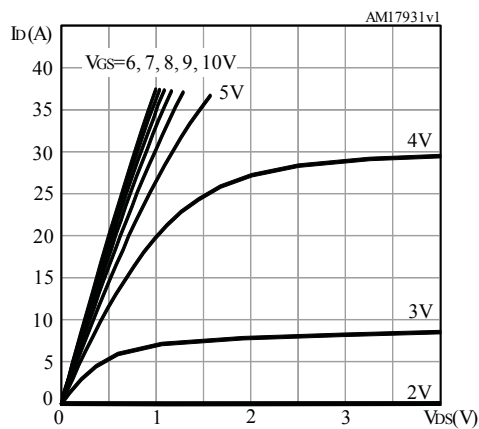
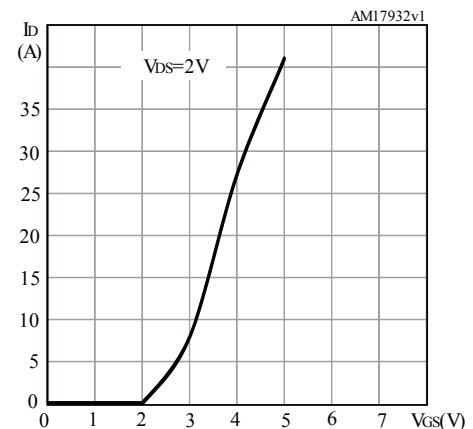
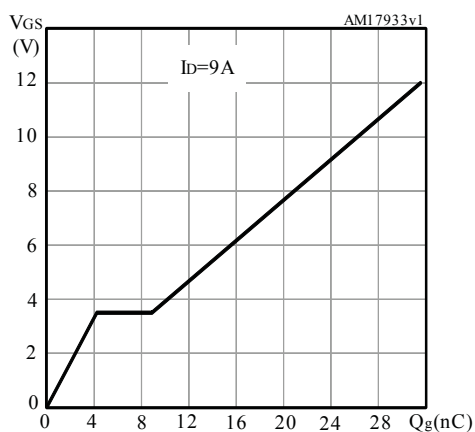
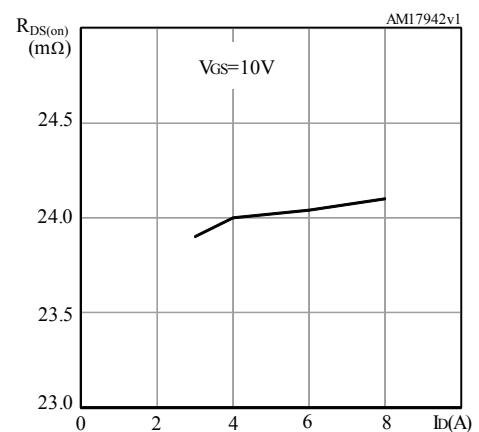
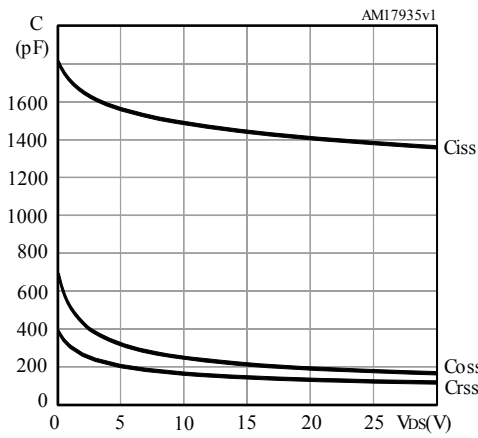
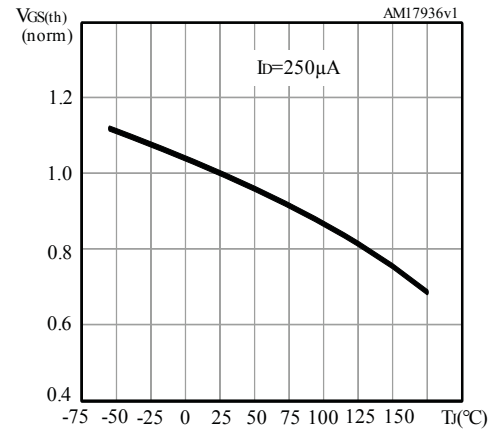
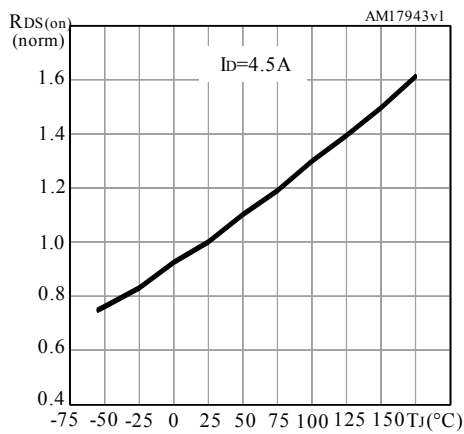
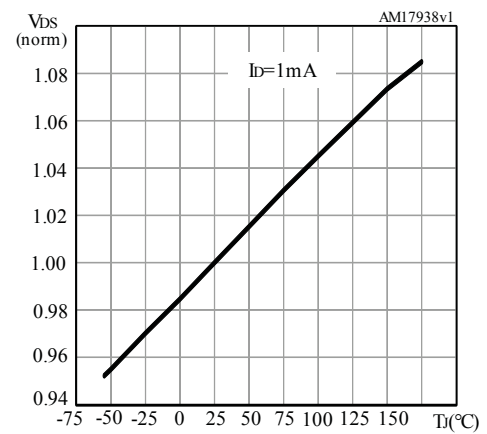
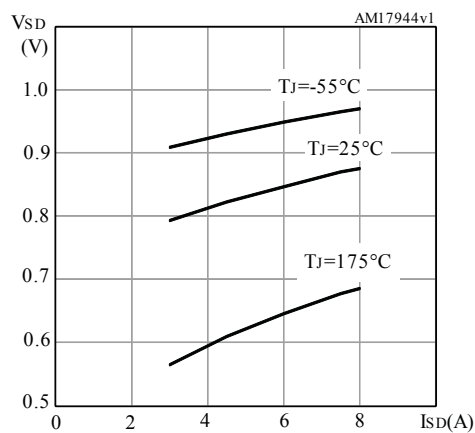
**Figure 1. Safe operating area**

**Figure 2. Thermal impedance**

**Figure 3. Output characteristics**

**Figure 4. Transfer characteristics**

**Figure 5. Gate charge vs gate-source voltage**

**Figure 6. Static drain-source on-resistance**


**Figure 7. Capacitance variations**

**Figure 8. Normalized gate threshold voltage vs temperature**

**Figure 9. Normalized on-resistance vs temperature**

**Figure 10. Normalized  $V_{DS}$  vs temperature**

**Figure 11. Source-drain diode forward characteristics**


### 3 Test circuits

**Figure 12. Switching times test circuit for resistive load**

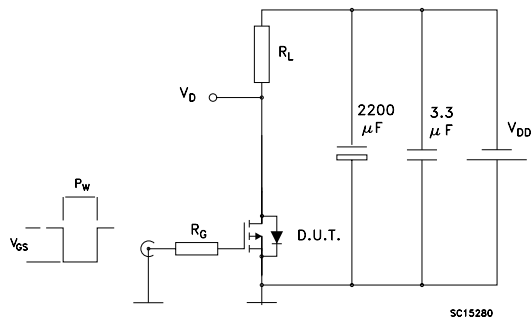


**Figure 13. Gate charge test circuit**

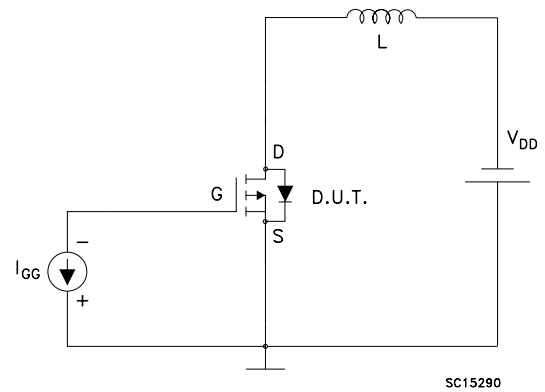
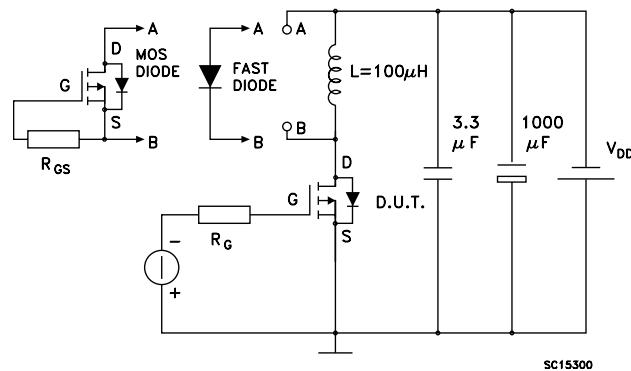


**Figure 14. Test circuit for inductive load switching and diode recovery times**

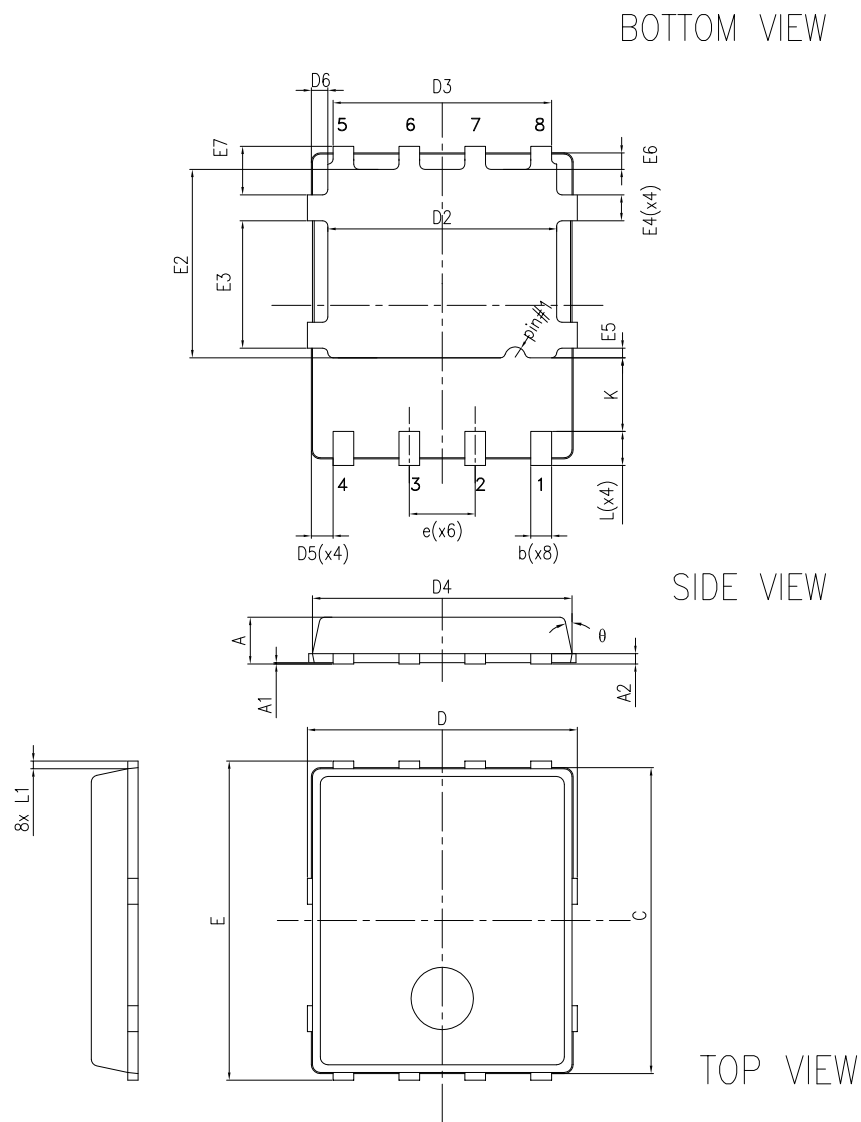


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 PowerFLAT 5x6 type R package information

**Figure 15. PowerFLAT 5x6 type R package outline**



A0ER\_8231817\_Rev20

**Table 7. PowerFLAT 5x6 type R mechanical data**

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 0.80  |       | 1.00  |
| A1   | 0.02  |       | 0.05  |
| A2   |       | 0.25  |       |
| b    | 0.30  |       | 0.50  |
| C    | 5.80  | 6.00  | 6.20  |
| D    | 5.00  | 5.20  | 5.40  |
| D2   | 4.15  |       | 4.45  |
| D3   | 4.05  | 4.20  | 4.35  |
| D4   | 4.80  | 5.00  | 5.20  |
| D5   | 0.25  | 0.40  | 0.55  |
| D6   | 0.15  | 0.30  | 0.45  |
| e    |       | 1.27  |       |
| E    | 5.95  | 6.15  | 6.35  |
| E2   | 3.50  |       | 3.70  |
| E3   | 2.35  |       | 2.55  |
| E4   | 0.40  |       | 0.60  |
| E5   | 0.08  |       | 0.28  |
| E6   | 0.20  | 0.325 | 0.45  |
| E7   | 0.75  | 0.90  | 1.05  |
| K    | 1.275 |       | 1.575 |
| L    | 0.60  |       | 0.80  |
| L1   | 0.05  | 0.15  | 0.25  |
| θ    | 0°    |       | 12°   |

## 4.2 PowerFLAT 5x6 type R SUBCON package information

Figure 16. PowerFLAT 5x6 type R SUBCON package outline

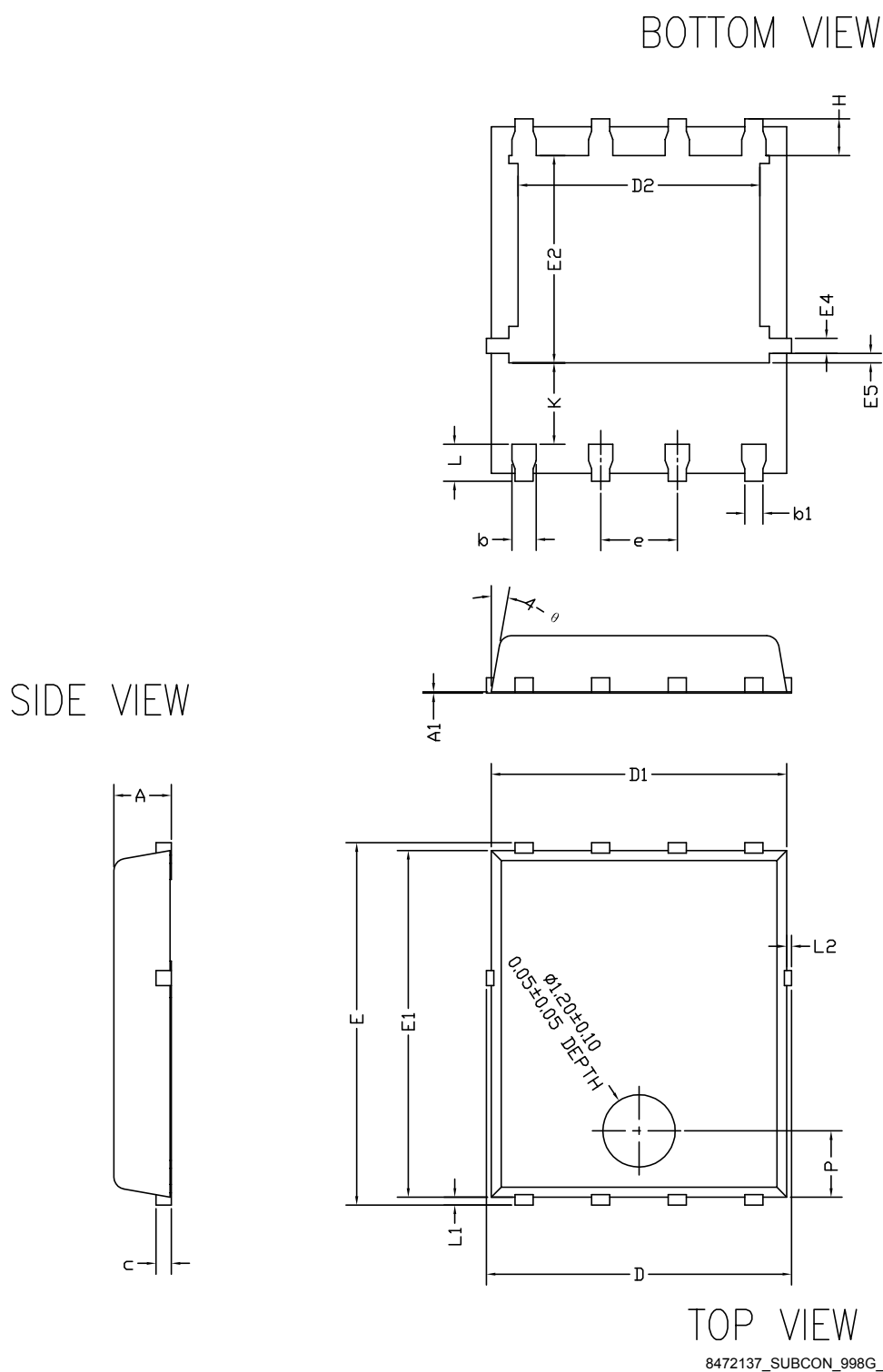
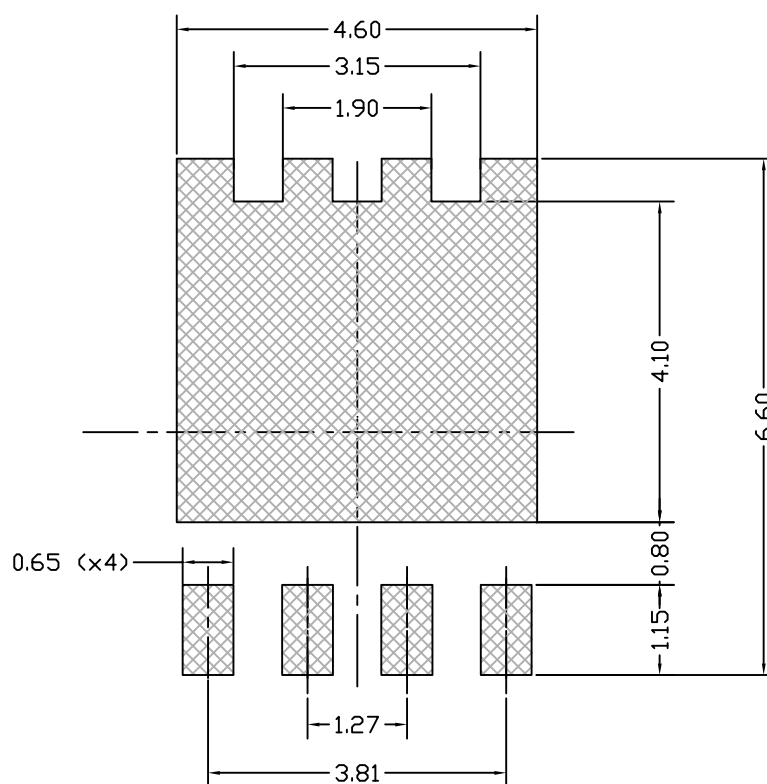


**Table 8. PowerFLAT 5x6 type R SUBCON package mechanical data**

| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 0.90 | 0.95 | 1.00 |
| A1   |      | 0.02 |      |
| b    | 0.35 | 0.40 | 0.45 |
| b1   |      | 0.30 |      |
| c    | 0.21 | 0.25 | 0.34 |
| D    |      |      | 5.10 |
| D1   | 4.80 | 4.90 | 5.00 |
| D2   | 3.91 | 4.01 | 4.11 |
| e    | 1.17 | 1.27 | 1.37 |
| E    | 5.90 | 6.00 | 6.10 |
| E1   | 5.70 | 5.75 | 5.80 |
| E2   | 3.34 | 3.44 | 3.54 |
| E4   | 0.15 | 0.25 | 0.35 |
| E5   | 0.06 | 0.16 | 0.26 |
| H    | 0.51 | 0.61 | 0.71 |
| K    | 1.10 |      |      |
| L    | 0.51 | 0.61 | 0.71 |
| L1   | 0.06 | 0.13 | 0.20 |
| L2   |      |      | 0.10 |
| P    | 1.00 | 1.10 | 1.20 |
| θ    | 8°   | 10°  | 12°  |

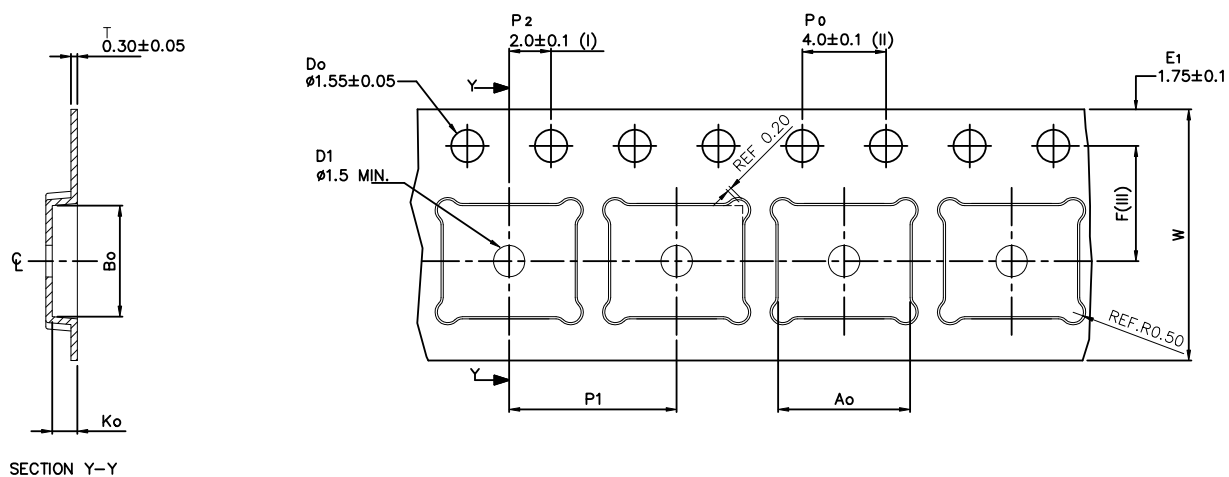
**Figure 17. PowerFLAT 5x6 recommended footprint (dimensions are in mm)**



8231817\_FOOTPRINT\_simp\_Rev\_20

### 4.3 PowerFLAT 5x6 packing information

Figure 18. PowerFLAT 5x6 tape (dimensions are in mm)



|    |               |
|----|---------------|
| A0 | 6.30 +/– 0.1  |
| B0 | 5.30 +/– 0.1  |
| K0 | 1.20 +/– 0.1  |
| F  | 5.50 +/– 0.1  |
| P1 | 8.00 +/– 0.1  |
| W  | 12.00 +/– 0.3 |

(I) Measured from centreline of sprocket hole to centreline of pocket.

(II) Cumulative tolerance of 10 sprocket holes is  $\pm 0.20$ .

(III) Measured from centreline of sprocket hole to centreline of pocket

Base and bulk quantity 3000 pcs  
 All dimensions are in millimeters

8234350\_Tape\_rev\_C

Figure 19. PowerFLAT 5x6 package orientation in carrier tape

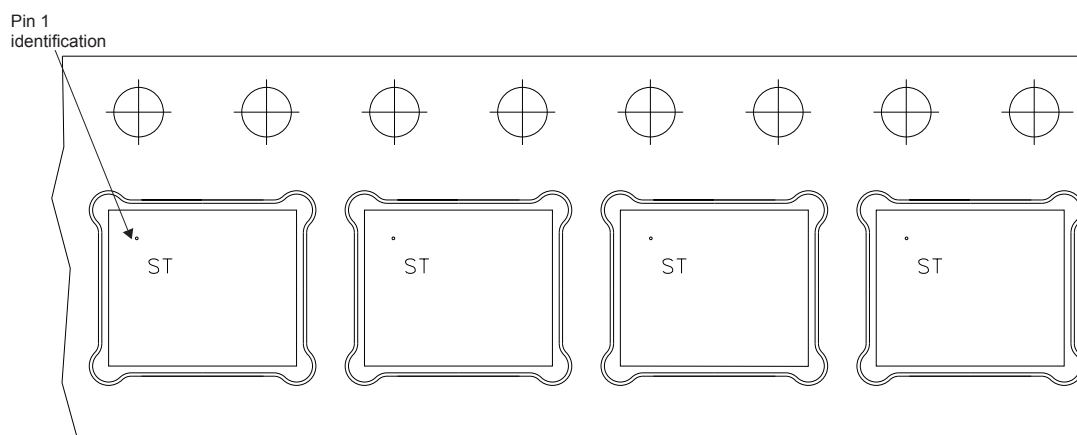
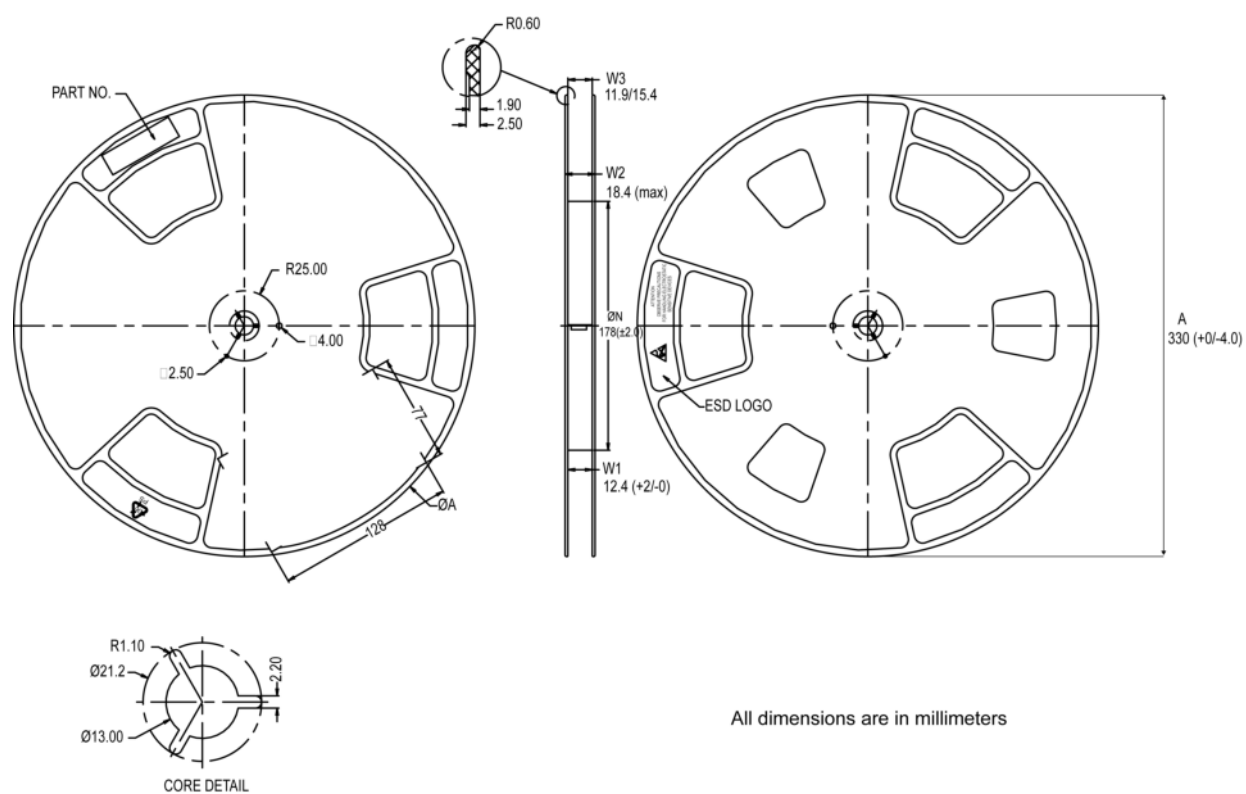


**Figure 20. PowerFLAT 5x6 reel**



8234350\_Reel\_rev\_C

## Revision history

**Table 9. Document revision history**

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 20-Mar-2013 | 1        | First release                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 28-Nov-2013 | 2        | <ul style="list-style-type: none"> <li>– Modified: title</li> <li>– Modified: <math>I_D</math>, <math>P_{TOT}</math> values and <i>Figure 1</i> in cover page</li> <li>– Modified: <math>V_{GS}</math>, <math>I_D</math> (at <math>T_{pcb} = 125\text{ °C}</math> and <math>T_{pcb} = 100\text{ °C}</math>), <math>I_{DM}</math>, <math>P_{TOT}</math> (at <math>T_C = 25\text{ °C}</math> and <math>T_{pcb} = 25\text{ °C}</math>) and <math>T_{stg}</math> in <i>Table 2</i></li> <li>– Modified: <math>R_{thj-pcb}</math> value in <i>Table 3</i></li> <li>– Modified: <math>I_{GSS}</math> (<math>V_{GS}</math> - test condition) value and <math>I_D</math> (for <math>R_{DS(on)}</math>) in <i>Table 4</i></li> <li>– Modified: <math>Q_g</math> value in <i>Table 5</i></li> <li>– Modified: <math>I_D</math> value in <i>Table 6</i></li> <li>– Modified: <math>I_{SD}</math> and <math>I_{SDM}</math> in <i>Table 7</i></li> <li>– Added: <i>Section 2.1: Electrical characteristics (curves)</i></li> <li>– Minor text changes</li> </ul> |
| 08-Jan-2014 | 3        | <ul style="list-style-type: none"> <li>– Modified: <math>T_J</math> value in <i>Table 2</i></li> <li>– Modified: <i>Figure 6</i></li> <li>– Updated: <i>Section 4: Package mechanical data</i></li> <li>– Minor text changes</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 03-Feb-2020 | 4        | Updated <i>Section 4 Package information</i> .<br>Minor text changes.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 18-Feb-2020 | 5        | Updated <a href="#">Internal schematic</a> in cover page.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |

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